



NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE6080A uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

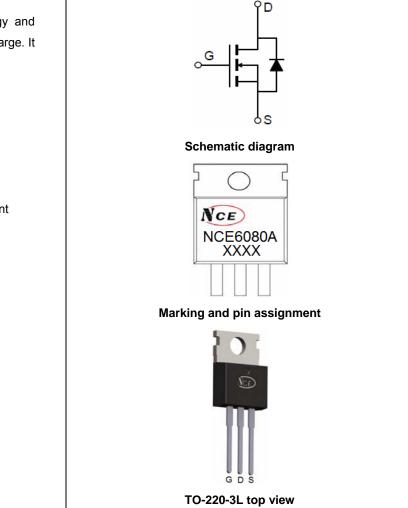
- V_{DS} =60V,I_D =80A
 R_{DS(ON)}=6.5mΩ (typical) @ V_{GS}=10V
 R_{DS(ON)}=7.5mΩ (typical) @ V_{GS}=4.5V
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- PWM
- Load Switching

100% UIS TESTED!

100% ΔVds TESTED!



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE6080A	NCE6080A	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_c=25℃ unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	Vds	60	V	
Gate-Source Voltage	Vgs	±20	V	
Drain Current-Continuous	ID	80	А	
Drain Current-Continuous(T _C =100 ℃)	I _D (100℃)	56.5	А	
Pulsed Drain Current	I _{DM}	320	А	
Maximum Power Dissipation	PD	110	W	
Derating factor		0.73	W/℃	
Single pulse avalanche energy (Note 5)	E _{AS}	390	mJ	
Operating Junction and Storage Temperature Range	TJ,TSTG	-55 To 175	°C	





NCE6080A

Thermal Characteristic

Thermal Resistance, Junction-to-Case ^(Note 2)	R _{θJC}	1.36	°C/W
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Electrical Characteristics (Tc=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	·					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA 60		-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =60V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	0.8	1.3	1.8	V
	R _{DS(ON)}	V _{GS} =10V, I _D =20A	-	6.5	8.0	mΩ
Drain-Source On-State Resistance		V _{GS} =4.5V, I _D =20A	-	7.5	9.5	mΩ
Forward Transconductance	g fs	V _{DS} =5V,I _D =20A	20	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	V _{DS} =30V,V _{GS} =0V,	-	4000	-	PF
Output Capacitance	C _{oss}	v _{DS} =30v,v _{GS} =0v, F=1.0MHz	-	290	-	PF
Reverse Transfer Capacitance	C _{rss}	F = 1.0101112	-	210	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t _{d(on)}		-	8.5	-	nS
Turn-on Rise Time	tr	V_{DD} =30V,RL=1 Ω	-	7	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V,R _G =3Ω	-	40	-	nS
Turn-Off Fall Time	t _f		-	15	-	nS
Total Gate Charge	Qg	V -20V(L-20A	-	90.3		nC
Gate-Source Charge	Q _{gs}	V _{DS} =30V,I _D =20A, V _{GS} =10V	-	10.9		nC
Gate-Drain Charge	Q _{gd}	VGS-TOV	-	20.6		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =20A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	80	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF = 20A	-	32	_	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/µs ^(Note3)	-	45	-	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD				y LS+LD)

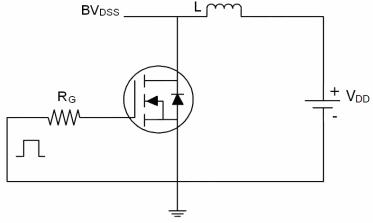
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^\circ \!\! C$,V_DD=30V,VG=10V,L=0.5mH,Rg=25 Ω

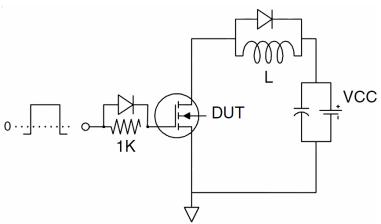




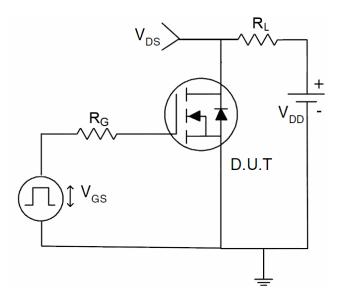
Test circuit 1) E_{AS} Test Circuit



2) Gate Charge Test Circuit



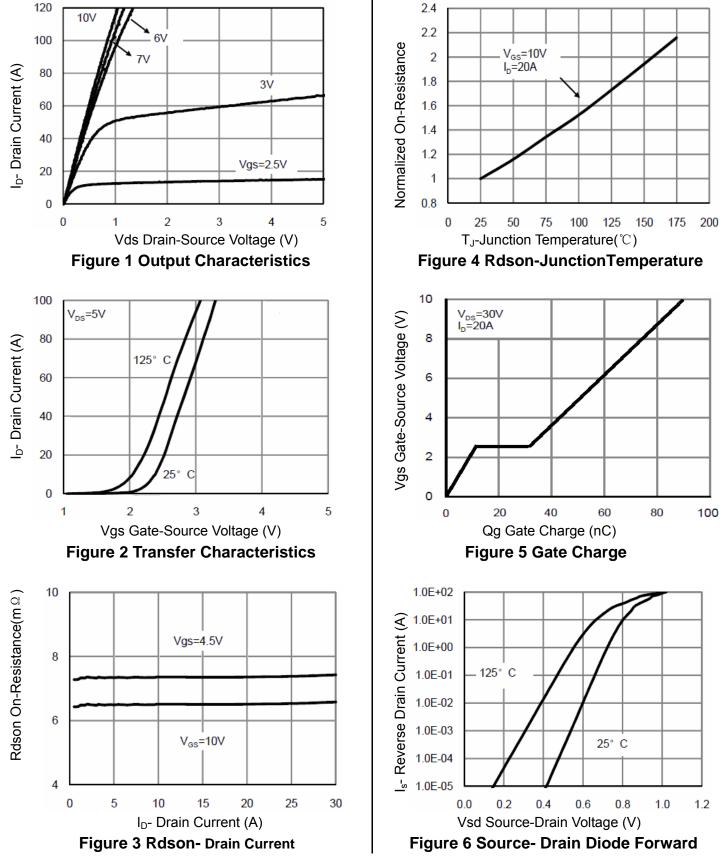
3) Switch Time Test Circuit





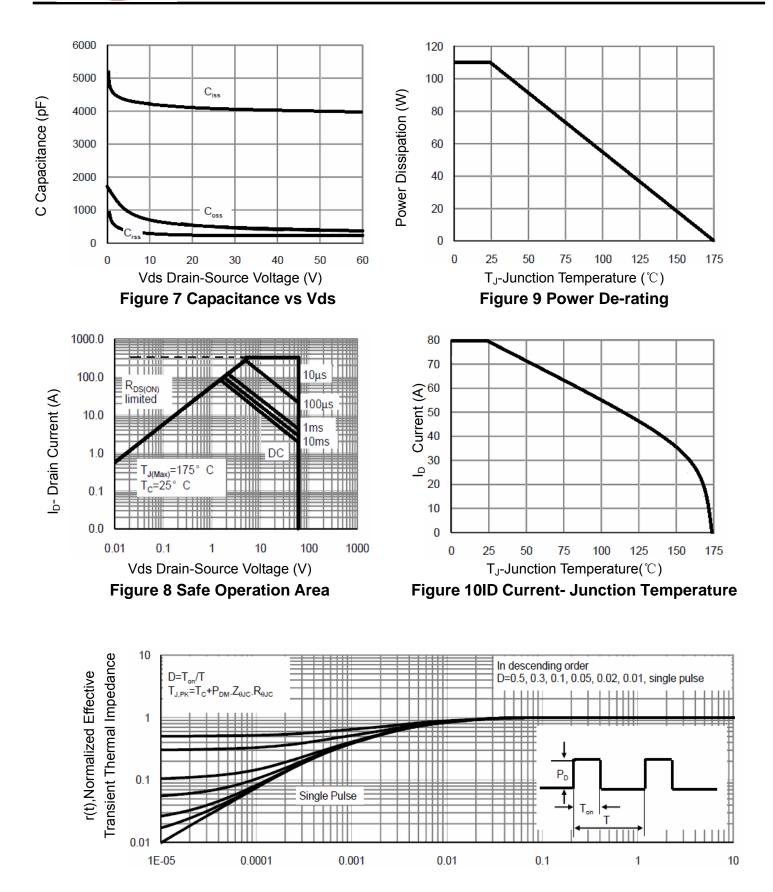












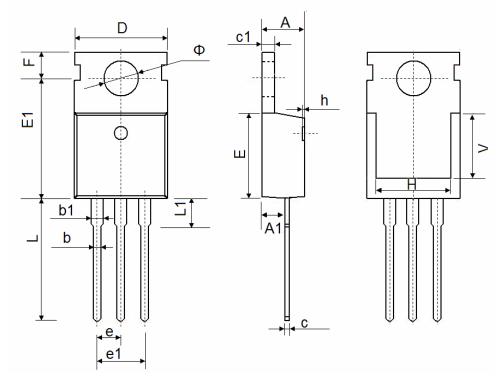
Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance





TO-220-3L Package Information



Symbol	Dimensions	n Millimeters	Dimensions In Inches			
	Min.	Max.	Min.	Max.		
A	4.400	4.600	0.173	0.181		
A1	2.250	2.550	0.089	0.100		
b	0.710	0.910	0.028	0.036		
b1	1.170	1.370	0.046	0.054		
С	0.330	0.650	0.013	0.026		
c1	1.200	1.400	0.047	0.055		
D	9.910	10.250	0.390	0.404		
E	8.9500	9.750	0.352	0.384		
E1	12.650	12.950	0.498	0.510		
е	2.540	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204		
F	2.650	2.950	0.104	0.116		
Н	7.900	8.100	0.311	0.319		
h	0.000	0.300	0.000	0.012		
L	12.900	13.400	0.508	0.528		
L1	2.850	3.250	0.112	0.128		
V	7.500 REF.		0.295 REF.			
Φ	3.400	3.800	0.134	0.150		





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